

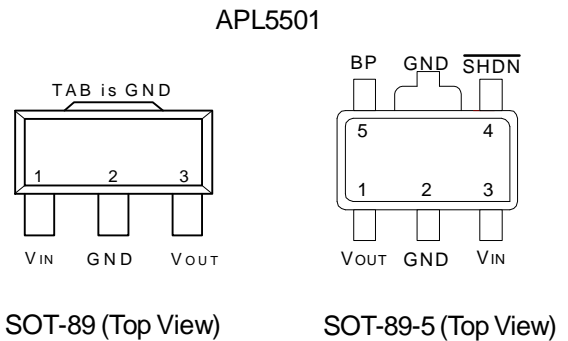
Low I_Q , Low Dropout 500mA Fixed Voltage Regulator

Features

- Low Noise : $50\mu V_{RMS}$ (100Hz to 100kHz)
- Low Quiescent Current : $50\mu A$ (No load)
- Low Dropout Voltage : 170mV (@500mA)
- Very low Shutdown Current : $< 0.5\mu A$
- Fixed Output Voltage : 1.3V ~ 3.4V
- Stable with 4.7uF Output Capacitor
- Stable with Aluminum, Tantalum or Ceramic Capacitors
- Reverse Current Protection
- No Protection Diodes Needed
- Built in Thermal Protection
- Built in Current Limit Protection
- Controlled Short Circuit Current : 150mA
- Fast Transient Response
- Short Setting Time
- SOT-23-5, SOT-89, SOT-89-5, SOT-223, SO-8, TO-252 and TO-252-5 Packages
- Lead Free Available (RoHS Compliant)

Design with an internal P-channel MOSFET pass transistor, the APL5501/2/3 maintains a low supply current, independent of the load current and dropout voltage. Other features include reverse current protection, thermal-shutdown protection, current limit protection to ensure specified output current and controlled short-circuit current. The APL5501/2/3 regulator comes in a miniature SOT-23-5, SOT-89, SOT-89-5, SOT-223, SO-8, TO-252 and TO-252-5 packages.

Pin Configuration

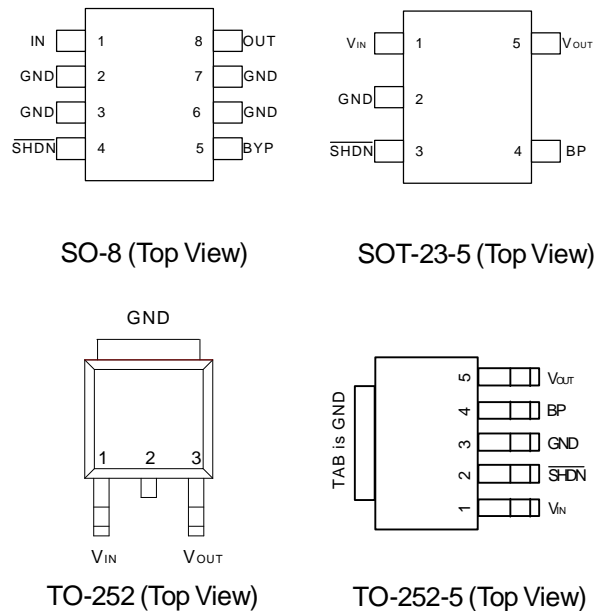


Applications

- Notebook Computer
- PDA or Portable Equipments
- Noise-Sensitive Instrumentation Systems

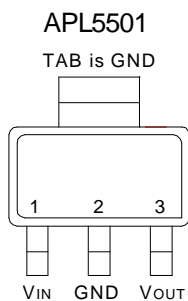
General Description

The APL5501/2/3 is micropower, low noise, low dropout linear regulator. Operate from 2.7V to 6V input voltage and deliver up to 500mA. Typical output noise is just $50\mu V_{RMS}$ with the addition of an external $0.1\mu F$ bypass capacitor in BP pin and typical dropout voltage is only 170mV at 500mA loading. Designed for use in battery-powered system, the low 50uA quiescent current makes it an ideal choice.

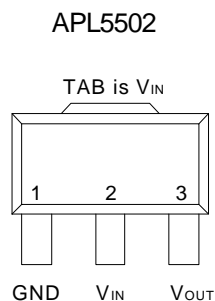


ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

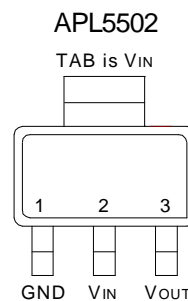
Pin Configuration (Cont.)



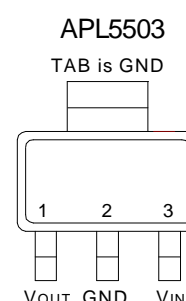
SOT-223 (Top View)



SOT-89 (Top View)

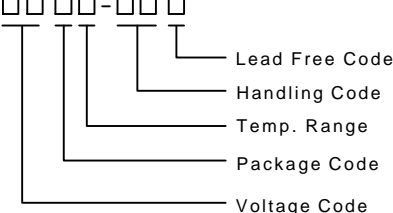



SOT-223 (Top View)



SOT-223 (Top View)

Ordering and Marking Information

| | |
|--|---|
| <p>APL5501/2/3 - □□□□-□□□</p>  <p>Lead Free Code Handling Code Temp. Range Package Code Voltage Code</p> | <p>Package Code B : SOT-23-5 D : SOT-89 D5 : SOT-89-5 U : TO-252 U5 : TO-252-5 V : SOT-223 K : SO-8 Temp. Range C : 0 to 70 °C Handling Code TR : Tape & Reel Voltage Code : 13 : 1.3V ~ 34 : 3.4V Lead Free Code L : Lead Free Device Blank : Original Device</p> |
| <p>APL5501/2/3 - 13 D/V/K : APL5501/2/3 XXXXX13</p> | <p>XXXXX - Date Code , 13 - 1.3V</p> |
| <p>APL5501/2/3 - 13 U :  13 APL5501/2/3 XXXXX</p> | <p>XXXXX - Date Code , 13 - 1.3V</p> |

Note: ANPEC lead-free products contain molding compounds/die attach materials and 100% matte in plate termination finish; which are fully compliant with RoHS and compatible with both SnPb and lead-free soldering operations. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J STD-020C for MSL classification at lead-free peak reflow temperature.

Marking Information

SOT-23-5 package

| Product Name | Marking | Product Name | Marking | Product Name | Marking |
|--------------|---------|--------------|---------|--------------|---------|
| APL5501-13B | 517X | APL5501-21B | 51FX | APL5501-28B | 51MX |
| APL5501-14B | 518X | APL5501-22B | 51GX | APL5501-29B | 51NX |
| APL5501-15B | 519X | APL5501-23B | 51HX | APL5501-30B | 51OX |
| APL5501-16B | 51AX | APL5501-24B | 51IX | APL5501-31B | 51PX |
| APL5501-17B | 51BX | APL5501-25B | 51JX | APL5501-32B | 51QX |
| APL5501-18B | 51CX | APL5501-26B | 51KX | APL5501-33B | 51RX |
| APL5501-19B | 51DX | APL5501-27B | 51LX | APL5501-34B | 51SX |
| APL5501-20B | 51EX | | | | |

The last character "X" in the marking is for data code.

Pin Description

| PIN | | I/O | Description |
|-----|----------------------------------|-----|--|
| No. | Name | | |
| 1 | V _{IN} | I | Supply voltage input. |
| 3 | $\overline{\text{SHDN}}$ (Note1) | I | Shutdown control pin, low = off , high = normal. Don't leave open. |
| 2 | GND | | Ground pins of the circuitry, and all ground pins must be soldered to PCB with proper power dissipation. |
| 4 | BP (Note1) | O | Bypass signal pin in fixed output type device |
| 5 | V _{OUT} | O | Output pin of the regulator. |

Note1: These pins do not exist in 3-pin package.

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit |
|------------------------------------|--|---|------|
| V _{IN} , V _{OUT} | Input Voltage or Out Voltage | 6.5 | V |
| $\overline{\text{SHDN}}$ | Shutdown Control Pin | 6.5 | V |
| R _{TH,JA} | Thermal Resistance - Junction to Ambient | SOT-89 : 180 SOT-223 : 135 SO-8 : 150 SOT-23-5 : 260 | °C/W |
| R _{TH,JC} | Thermal Resistance - Junction to Case | SOT-89 : 38 SOT-223 : 15 SO-8 : 20 SOT-23-5 : 130 | °C/W |
| P _d | Power Dissipation | Internally Limited | W |
| T _J | Operating Junction Temperature | | °C |
| | Control Section | 0 to 125 | |
| | Power Transistor | 0 to 150 | |
| T _{STG} | Storage Temperature Range | -65 to +150 | °C |
| T _L | Lead Temperature (Soldering, 10 second) | 260 | °C |

Electrical Characteristics

Unless otherwise noted these specifications apply over full temperature, V_{IN}=3.6V, C_{IN}=1μF, C_{OUT}=4.7μF, SHDN=V_{IN}, T_J=0 to 125°C. Typical values refer to T_J=25°C.

| Symbol | Parameter | Test Conditions | APL5501/2/3 | | | Unit |
|------------------|----------------|--|----------------------|------------------|----------------------|------|
| | | | Min. | Typ. | Max. | |
| V _{IN} | Input Voltage | | 2.7 | | 6 | V |
| V _{OUT} | Output Voltage | V _{OUT} +1.0V < V _{CC} < 6.0V, 0mA < I _{OUT} < I _{MAX} | V _{OUT} -2% | V _{OUT} | V _{OUT} +2% | V |

Electrical Characteristics

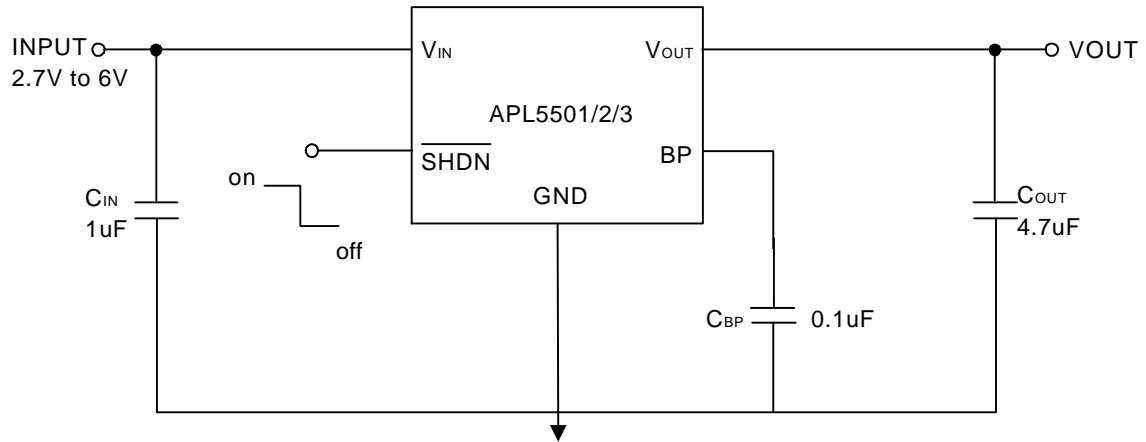
Unless otherwise noted these specifications apply over full temperature, $V_{IN}=3.6V$, $C_{IN}=1\mu F$, $C_{OUT}=4.7\mu F$, $SHDN=V_{IN}$, $T_J=0$ to $125^\circ C$. Typical values refer to $T_J=25^\circ C$.

| Symbol | Parameter | Test Conditions | APL5501/2/3 | | | Unit |
|--------------|--|---|----------------------------|------|------|--------------------|
| | | | Min. | Typ. | Max. | |
| I_{LIMIT} | Circuit Current Limit | $V_{IN}=4.3V$ | | 0.7 | | A |
| I_{SHORT} | Short Current | $V_{OUT}=0V$ | | 200 | | mA |
| I_{OUT} | Load Current | | 500 | | | mA |
| REG_{LINE} | Line Regulation | $V_{OUT}+0.5V < V_{CC} < 6.0V$, $I_{OUT} = 1mA$ | | 4 | 10 | mV |
| REG_{LOAD} | Load Regulation | $V_{IN} = V_{OUT}+1.0V$, $0mA < I_{OUT} < I_{MAX}$ | | 1 | 6 | mV |
| V_{DROP} | Dropout Voltage ^(Note2) | $I_{OUT} = 500mA$ | $1.3V \leq V_{OUT} < 1.5V$ | 1100 | 1300 | mV |
| | | | $1.5V \leq V_{OUT} < 2V$ | 900 | 1050 | |
| | | | $2V \leq V_{OUT} < 2.5V$ | 500 | 700 | |
| | | | $2.5V \leq V_{OUT} < 3.4V$ | 280 | 380 | |
| PSRR | Ripple Rejection | $F \leq 1kHz$, $1V_{pp}$ at $V_{IN} = V_{OUT}+1.0V$ | 55 | 65 | | dB |
| I_Q | Quiescent Current | No load | | 50 | 100 | μA |
| | | $I_{OUT}=500mA$ | | 370 | 450 | |
| | Shutdown Supply Current ^(Note3) | Shutdown = low $I_{OUT}=0$, $V_{CC} = 6.0V$ | | 0.01 | 1 | μA |
| | Noise ^(Note3) | $100Hz < f < 100kHz$, typical load, $C_{BP}=0.01\mu F$, $C_{OUT} = 1\mu F$ | | 50 | | μV_{rms} |
| | | $100Hz < f < 100kHz$, typical load, $C_{BP}=0.1\mu F$, $C_{OUT} = 1\mu F$ | | 40 | | |
| | Shutdown Recovery Delay ^(Note3) | $C_{BP}=0.01\mu F$, $C_{OUT}=1\mu F$, no load | | 7 | | ms |
| | | $C_{BP}=0.1\mu F$, $C_{OUT}=1\mu F$, no load | | 70 | | |
| OTS | Over Temperature Shutdown | | | 150 | | $^\circ C$ |
| | Over Temperature Shutdown Hysteresis | Hysteresis | | 10 | | $^\circ C$ |
| TC | Output Voltage Temperature Coefficient | | | 50 | | ppm/ $^\circ C$ |
| C_{OUT} | Output Capacitor | | 4.2 | 4.7 | 5.2 | μF |
| | ESR | | 0.02 | 0.1 | 1 | Ohm |
| | Shutdown Input Threshold ^(Note3) | $V_{OUT}+1.0V < V_{IN} < 6.0V$ | 0.4 | 0.7 | 1.6 | V |
| I_{SHDN} | Shutdown input Bias current ^(Note3) | $V_{SHDN} = V_{IN}$ | | 0.01 | 100 | nA |
| | Input Reverse Leakage current | $V_{OUT}-V_{IN}=0.1V$ | | 0.1 | 0.5 | μA |
| | Reverse Protection Threshold | | | 11 | 50 | mV |

Note 2 : Dropout voltage definition : $V_{IN}-V_{OUT}$ when V_{OUT} is 2% below the value of V_{OUT} for $V_{IN} = V_{OUT} + 0.5V$

Note 3 : For 5-pin devices only.

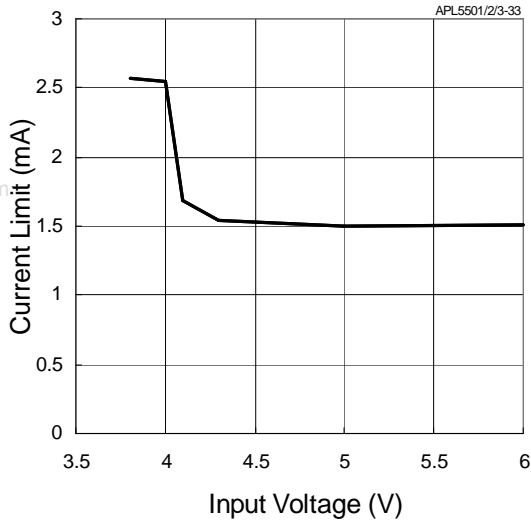
Application Circuit



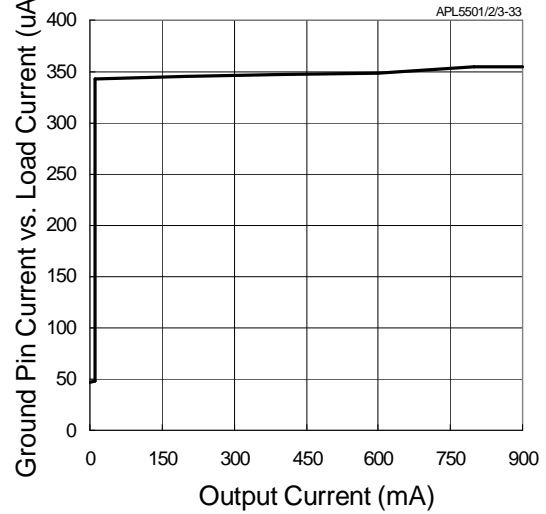
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Typical Characteristics

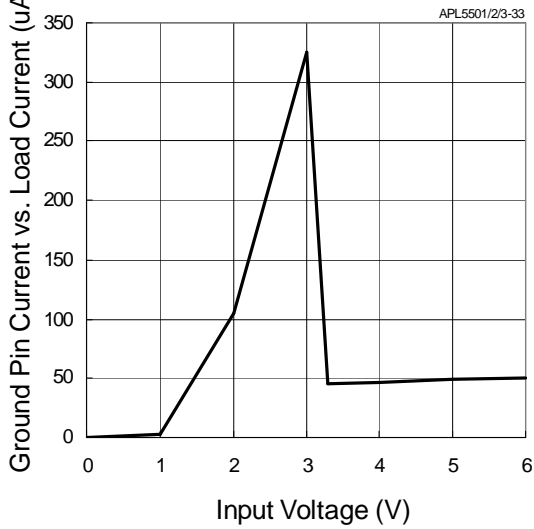
Current Limit vs. Input Voltage



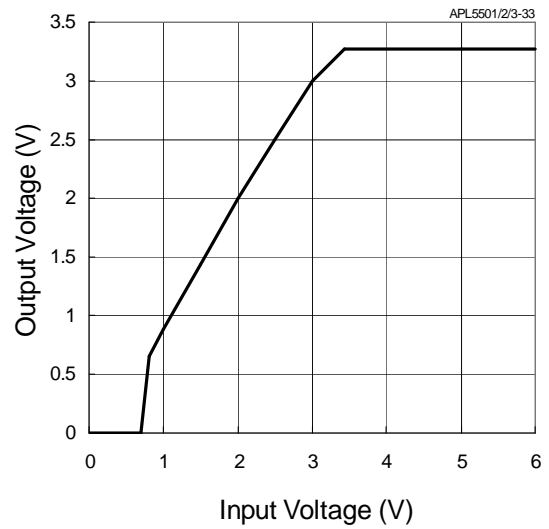
Ground Pin Current vs. Output Current



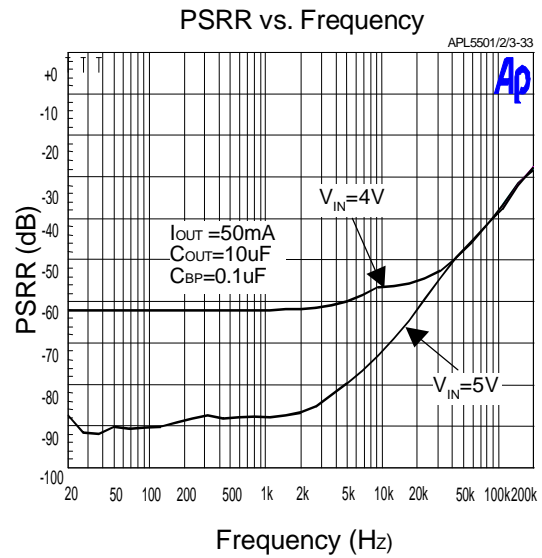
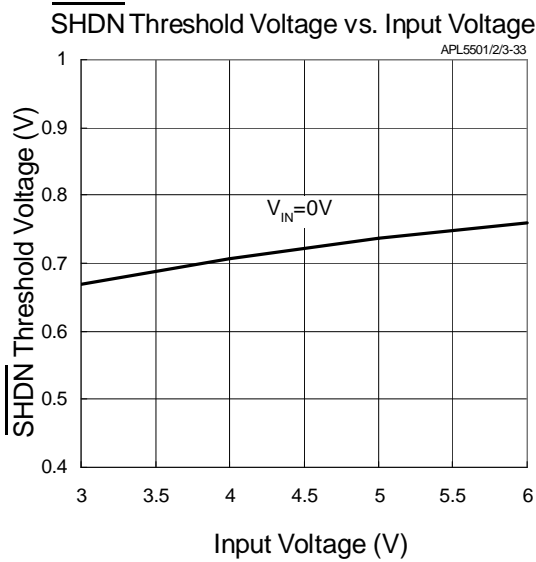
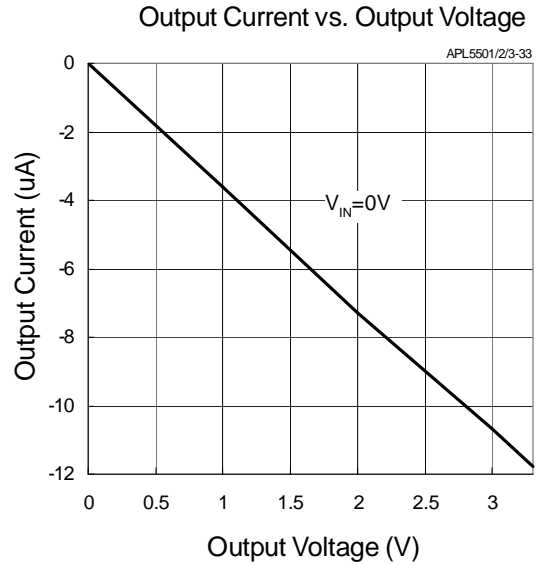
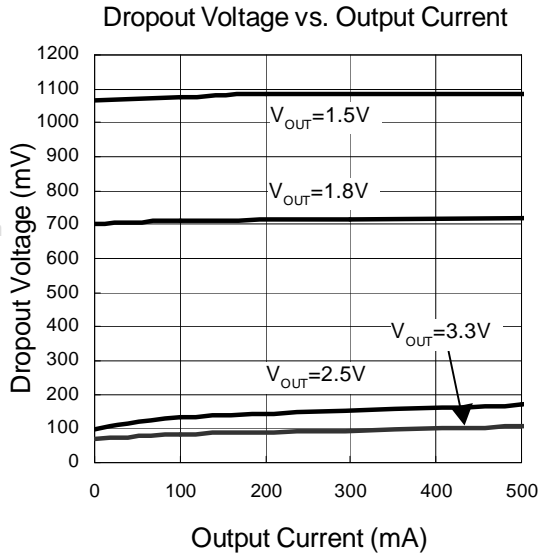
Ground Pin Current vs. Input Voltage



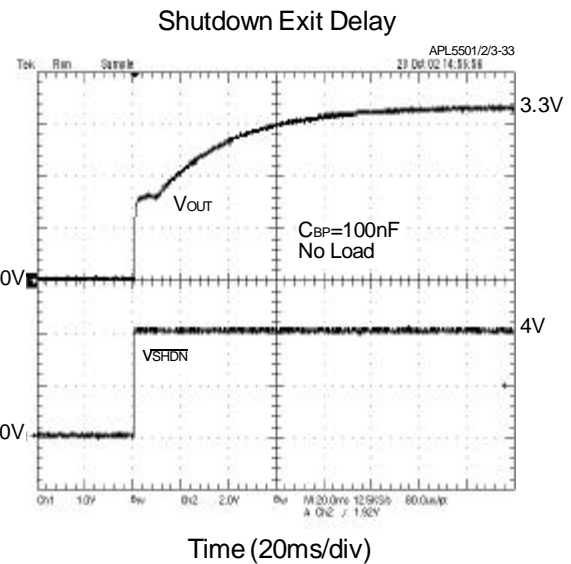
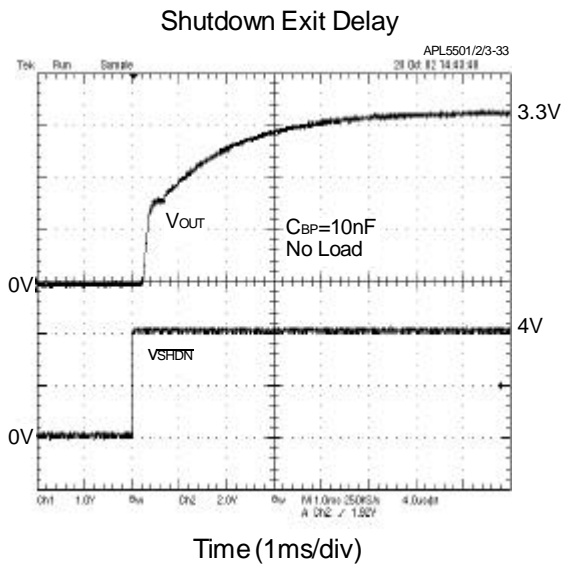
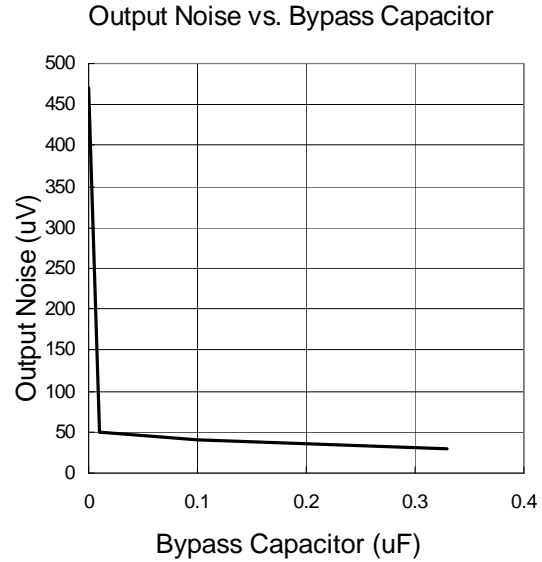
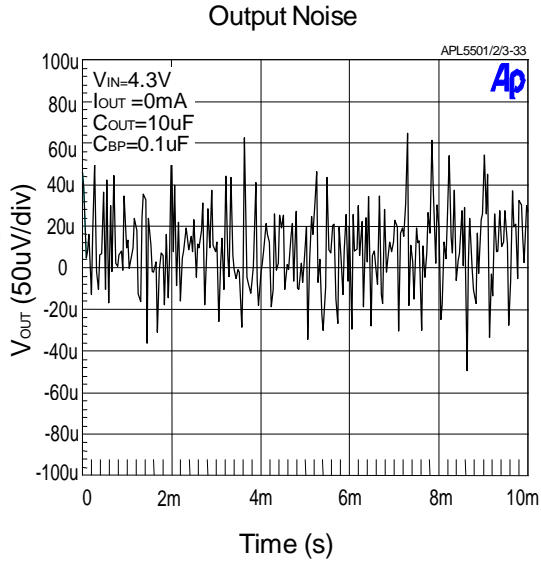
Input Voltage vs. Output Voltage



Typical Characteristics

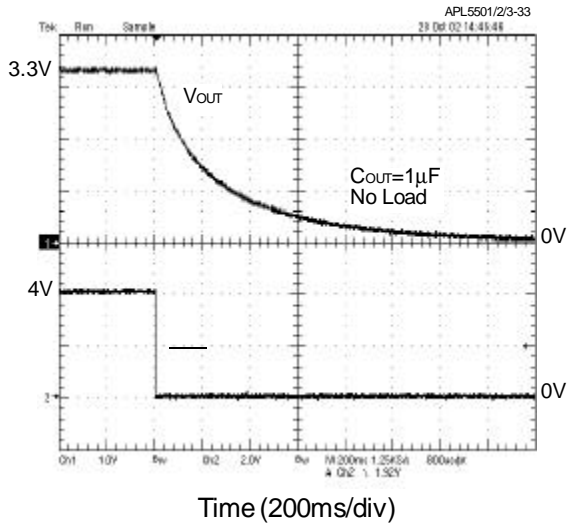


Typical Characteristics

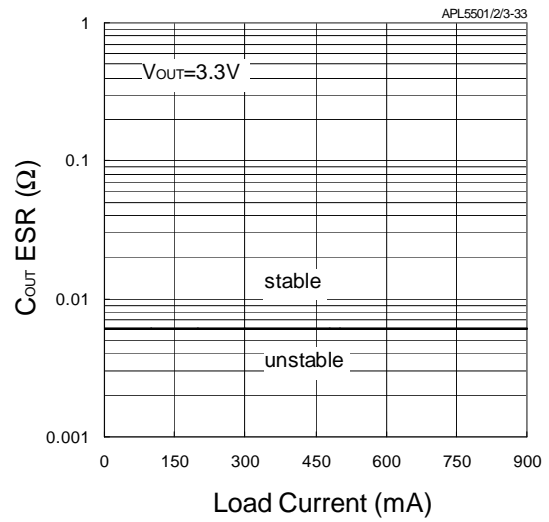


Typical Characteristics

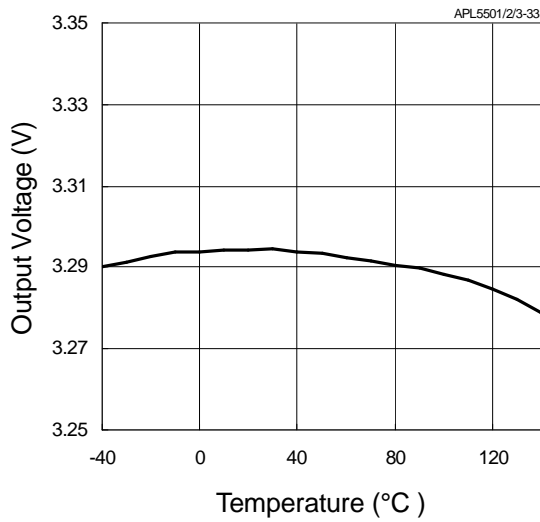
Entering Shutdown



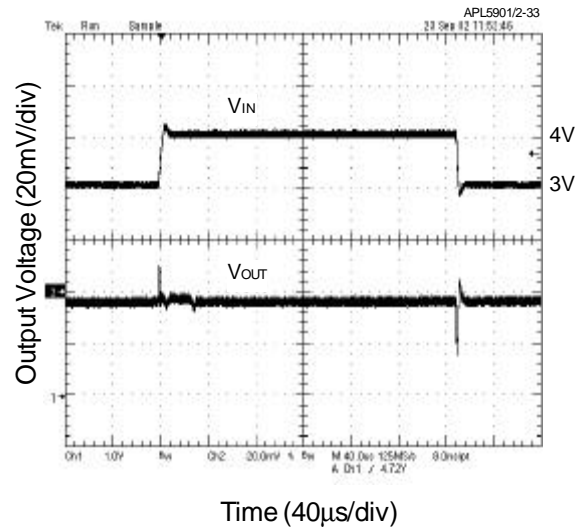
Region of Stable ESR vs. Load Current



Output Voltage vs. Temperature

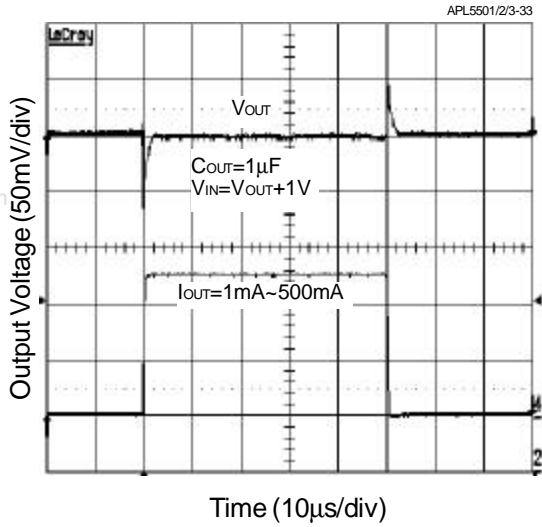


Line-Transient Response



Typical Characteristics

Load-Transient Response



Application Information

Capacitor Selection and Regulator Stability

The APL5501/2/3 use at least a 1 μ F capacitor on the input, and this capacitor can be Aluminum, Tantalum or Ceramic capacitor. The input capacitor with larger value and lower ESR provides better PSRR and line-transient response. The output capacitor also can use Aluminum, Tantalum or Ceramic capacitor, and a minimum value of 1 μ F and ESR above 0.06 Ω is recommended. The curve of the stable region in typical characteristics shows the appropriate output capacitor ESR for different load current stable operation. A larger output capacitor can reduce noise and improve load-transient response, stability, and PSRR. Note that some ceramic dielectrics exhibit large capacitance and ESR variation with temperature. When using this capacitor, a minimum 10 μ F or more may be required to ensure the stability at low temperature operation. Use a bypass capacitor at BP pin for low output noise. Increasing the capacitance will slightly decrease the output noise, but increase the start-up time.

Load-Transient Considerations

The APL5501/2/3 load-transient response graphs in typical characteristics show the transient response. A step change in the load current from 0mA to 500mA at 1 μ s will cause a 100mV transient spike. Larger output capacitor and lower ESR can reduce transient spike.

Input-Output (Dropout)Voltage

The minimum input-output voltage difference (dropout) determines the lowest usable supply voltage. In battery-powered systems, this will determine the useful

end-of-life battery voltage. Because the APL5501/2/3 use a p-channel MOSFET pass transistor, the dropout voltage is a function of drain-to-source on-resistance ($R_{DS(ON)}$) multiplied by the load current.

Reverse Current Protection

The APL5501/2/3 have an internal reverse protection, it does not need an external schottky diode to connect the regulator input and output. If the output voltage is forced above the input voltage by more than 11mV, the IC will be shutdown and the ground pin current is below 0.1 μ A.

Shutdown/Enable

The APL5501/2/3 have an active high enable function. Force EN high (>1.6V) enables the regulator, EN low (<0.4V) disables the regulator and enter the shutdown mode. In shutdown mode, the quiescent current can reduce below 1 μ A. The EN pin cannot be floating, a floating EN pin may cause an indeterminate state on the output. If it is no use, connect to V_{IN} for normal operation.

Current Limit

The APL5501/2/3 have a current limit protection. The output voltage will drop close to zero volt, when load current reaches the limit, and then the load current will be limited at 150mA after output voltage is below 0.7V. When the load current back to the value where limiting started, the output voltage and current will return to normal value. When output is shorted to ground, the APL5501/2/3 will keep short circuit current at 150mA .

Thermal Protection

Thermal protection limits total power dissipation in the device. When the junction temperature exceeds $T_J=+150$, the thermal sensor generates a logic signal to turn off the pass transistor and allows IC to cool. When the IC's junction temperature is down by 10 , the thermal sensor will turn the pass transistor on again, resulting in a pulsed output during continuous thermal protection. Thermal protection is designed to protect the APL5501/2/3 in the event of fault conditions. For continuous operation, do not exceed the absolute maximum junction temperature of $T_J=+150$.

Operating Region and Power Dissipation

The thermal resistance of the case to circuit board, and the rate of air flow all control the APL5501/2/3's maximum power dissipation. The power dissipation across the device is $P_D = I_{OUT}(V_{IN}-V_{OUT})$ and the maximum power dissipation is:

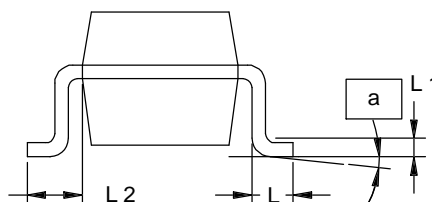
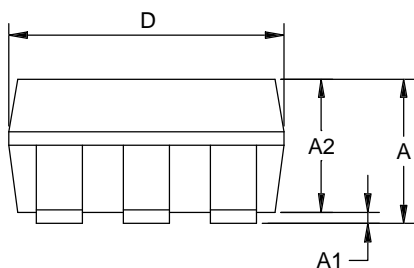
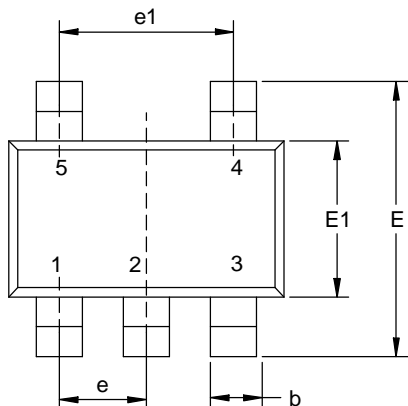
$$P_{D_{MAX}} = (T_J - T_A) / (\theta_{JC} + \theta_{CA})$$

where $T_J - T_A$ is the temperature difference between the junction and ambient air, θ_{JC} is the thermal resistance of the package, and θ_{CA} is the thermal resistance through the printed circuit board, copper traces, and other materials to the ambient air.

The GND pin of the APL5501/3 provide an electrical connection to ground and channeling heat away. If power dissipation is large, connect the GND pin to ground using a large pad or ground plane, can improve the problem of over heat of IC.

Packaging Information

SOT-23-5

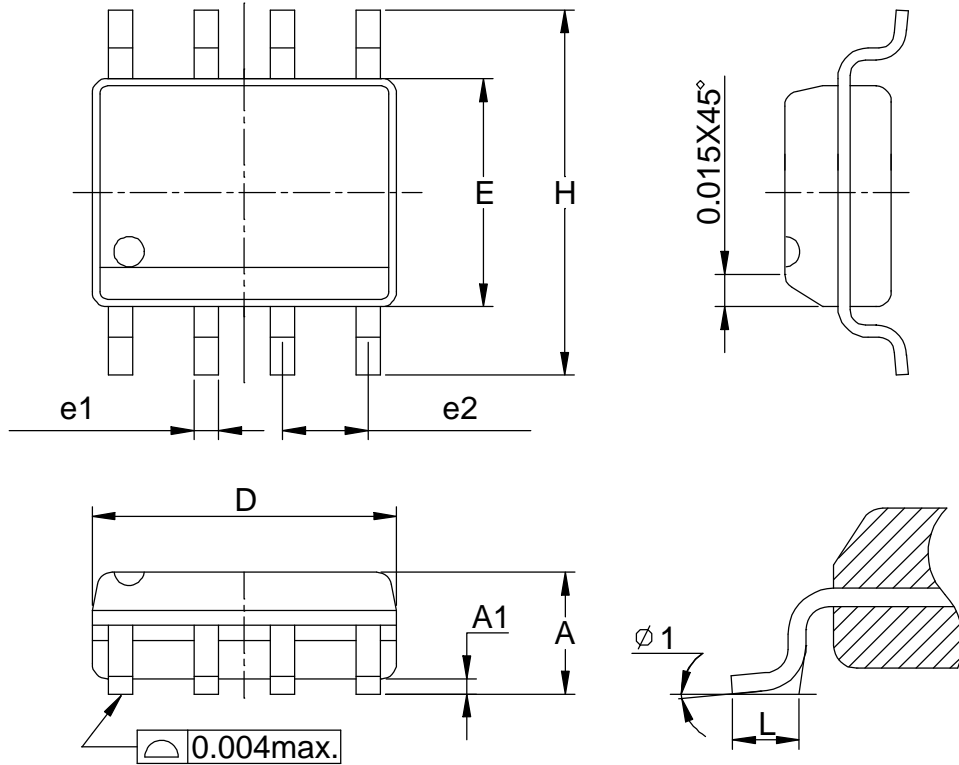


| Dim | Millimeters | | Inches | |
|----------|-------------|------|-----------|-------|
| | Min. | Max. | Min. | Max. |
| A | 0.95 | 1.45 | 0.037 | 0.057 |
| A1 | 0.05 | 0.15 | 0.002 | 0.006 |
| A2 | 0.90 | 1.30 | 0.035 | 0.051 |
| D | 2.8 | 3.00 | 0.110 | 0.118 |
| E | 2.6 | 3.00 | 0.102 | 0.118 |
| E1 | 1.5 | 1.70 | 0.059 | 0.067 |
| L | 0.35 | 0.55 | 0.014 | 0.022 |
| L1 | 0.20 BSC | | 0.008 BSC | |
| L2 | 0.5 | 0.7 | 0.020 | 0.028 |
| N | 5 | | 5 | |
| α | 0° | 10° | 0° | 10° |

Packaging Information

SOP-8 pin (Reference JEDEC Registration MS-012)

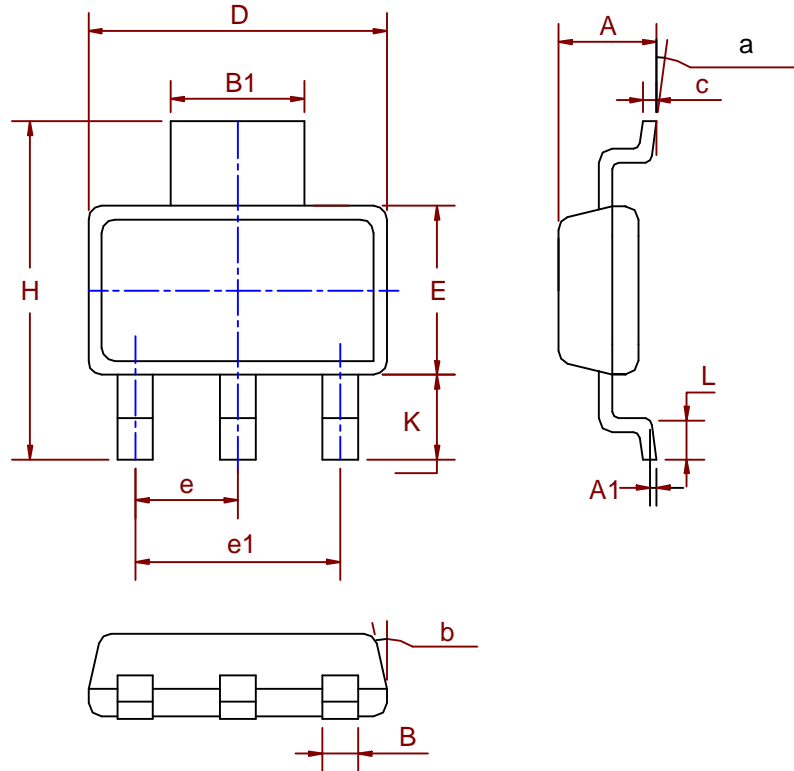
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| Dim | Millimeters | | Inches | |
|-----|-------------|------|---------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.35 | 1.75 | 0.053 | 0.069 |
| A1 | 0.10 | 0.25 | 0.004 | 0.010 |
| D | 4.80 | 5.00 | 0.189 | 0.197 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| L | 0.40 | 1.27 | 0.016 | 0.050 |
| e1 | 0.33 | 0.51 | 0.013 | 0.020 |
| e2 | 1.27BSC | | 0.50BSC | |
| φ 1 | 8° | | 8° | |

Packaging Information

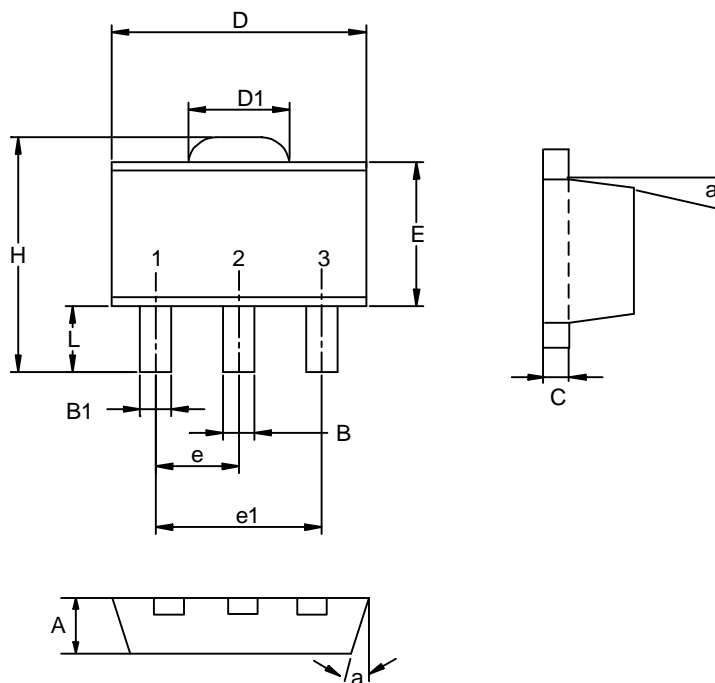
SOT-223(Reference JEDEC Registration SOT-223)



| Dim | Millimeters | | Inches | |
|-----|-------------|------|----------|------|
| | Min. | Max. | Min. | Max. |
| A | 1.50 | 1.80 | 0.06 | 0.07 |
| A1 | 0.02 | 0.08 | | |
| B | 0.60 | 0.80 | 0.02 | 0.03 |
| B1 | 2.90 | 3.10 | 0.11 | 0.12 |
| c | 0.28 | 0.32 | 0.01 | 0.01 |
| D | 6.30 | 6.70 | 0.25 | 0.26 |
| E | 3.30 | 3.70 | 0.13 | 0.15 |
| e | 2.3 BSC | | 0.09 BSC | |
| e1 | 4.6 BSC | | 0.18 BSC | |
| H | 6.70 | 7.30 | 0.26 | 0.29 |
| L | 0.91 | 1.10 | 0.04 | 0.04 |
| K | 1.50 | 2.00 | 0.06 | 0.08 |
| α | 0° | 10° | 0° | 10° |
| β | 13° | | 13° | |

Packaging Information

SOT-89 (Reference EIAJ ED-7500A Registration SC-62)



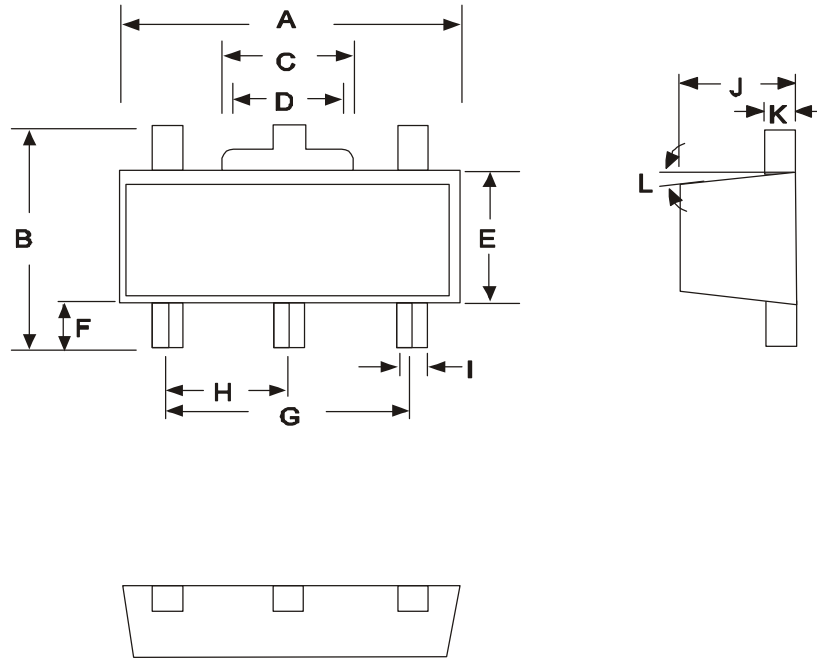
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| Dim | Millimeters | | Inches | |
|-----|-------------|------|-----------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.40 | 1.60 | 0.055 | 0.063 |
| B | 0.40 | 0.56 | 0.016 | 0.022 |
| B1 | 0.35 | 0.48 | 0.014 | 0.019 |
| C | 0.35 | 0.44 | 0.014 | 0.017 |
| D | 4.40 | 4.60 | 0.173 | 0.181 |
| D1 | 1.35 | 1.83 | 0.053 | 0.072 |
| e | 1.50 BSC | | 0.059 BSC | |
| e1 | 3.00 BSC | | 0.118 BSC | |
| E | 2.29 | 2.60 | 0.090 | 0.102 |
| H | 3.75 | 4.25 | 0.148 | 0.167 |
| L | 0.80 | 1.20 | 0.031 | 0.047 |
| α | | 10° | | 10° |

Packaging Information

SOT-89-5

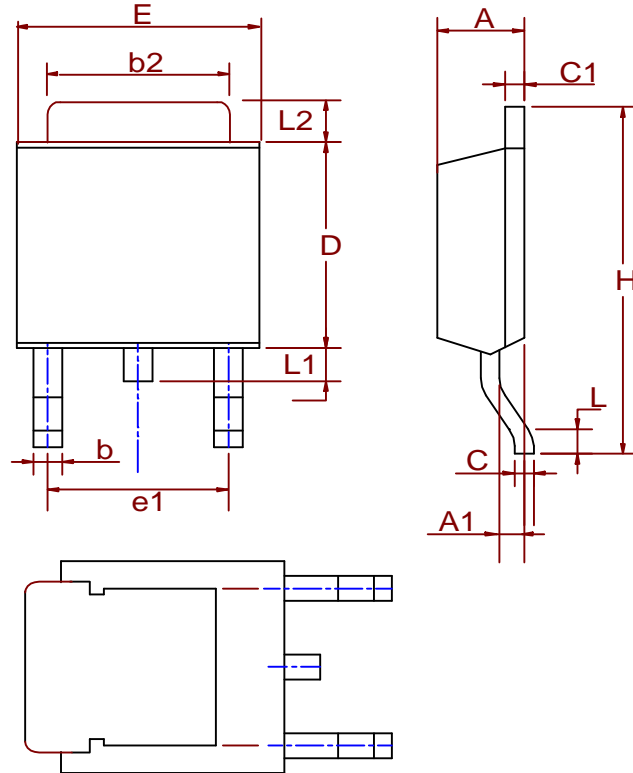
www.DataSheet4U.com



| Dim | Millimeters | | Inches | |
|-----|-------------|------|----------|------|
| | Min. | Max. | Min. | Max. |
| A | 4.40 | 4.60 | 0.17 | 0.18 |
| B | 4.05 | 4.25 | 0.16 | 0.17 |
| C | 1.50 | 1.70 | 0.06 | 0.07 |
| D | 1.30 | 1.50 | 0.05 | 0.06 |
| E | 2.40 | 2.60 | 0.09 | 0.1 |
| F | 0.80 | - | 0.03 | - |
| G | 3.00 REF | | 0.12 REF | |
| H | 1.50 REF | | 0.06 REF | |
| I | 0.40 | 0.52 | 0.01 | 0.02 |
| J | 1.40 | 1.60 | 0.05 | 0.06 |
| K | 0.35 | 0.41 | 0.01 | 0.02 |
| L | 5 TYP | | 0.2 TYP | |

Packaging Information

TO-252(Reference JEDEC Registration TO-252)



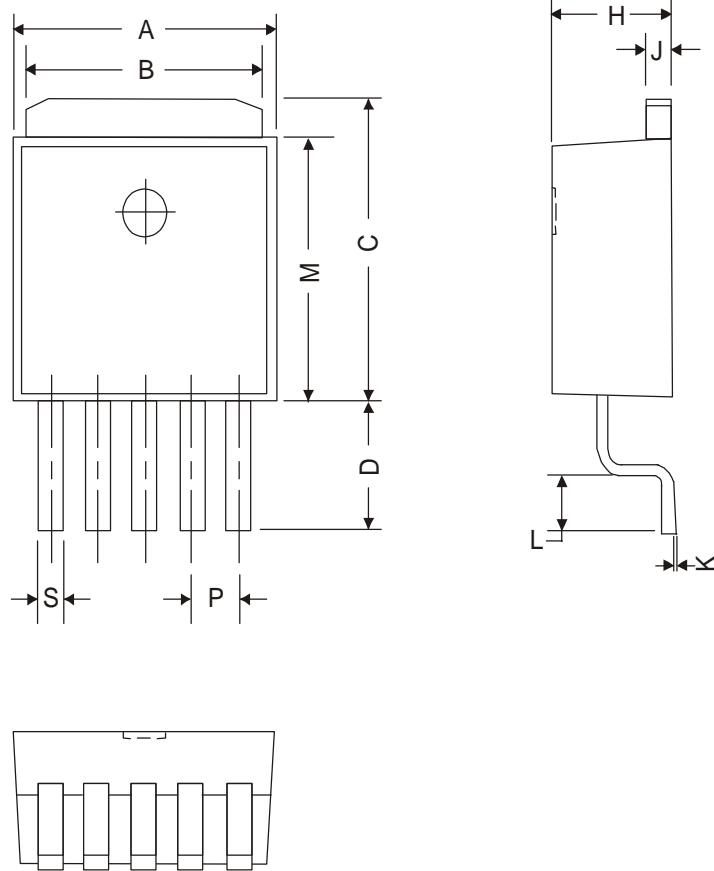
www.DataSheet4U.com

| Dim | Millimeters | | Inches | |
|-----|-------------|-------|--------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.18 | 2.39 | 0.086 | 0.094 |
| A1 | 0.89 | 1.27 | 0.035 | 0.050 |
| b | 0.508 | 0.89 | 0.020 | 0.035 |
| b2 | 5.207 | 5.461 | 0.205 | 0.215 |
| C | 0.46 | 0.58 | 0.018 | 0.023 |
| C1 | 0.46 | 0.58 | 0.018 | 0.023 |
| D | 5.334 | 6.22 | 0.210 | 0.245 |
| E | 6.35 | 6.73 | 0.250 | 0.265 |
| e1 | 3.96 | 5.18 | 0.156 | 0.204 |
| H | 9.398 | 10.41 | 0.370 | 0.410 |
| L | 0.51 | | 0.020 | |
| L1 | 0.64 | 1.02 | 0.025 | 0.040 |
| L2 | 0.89 | 2.032 | 0.035 | 0.080 |

Packaging Information

TO-252-5

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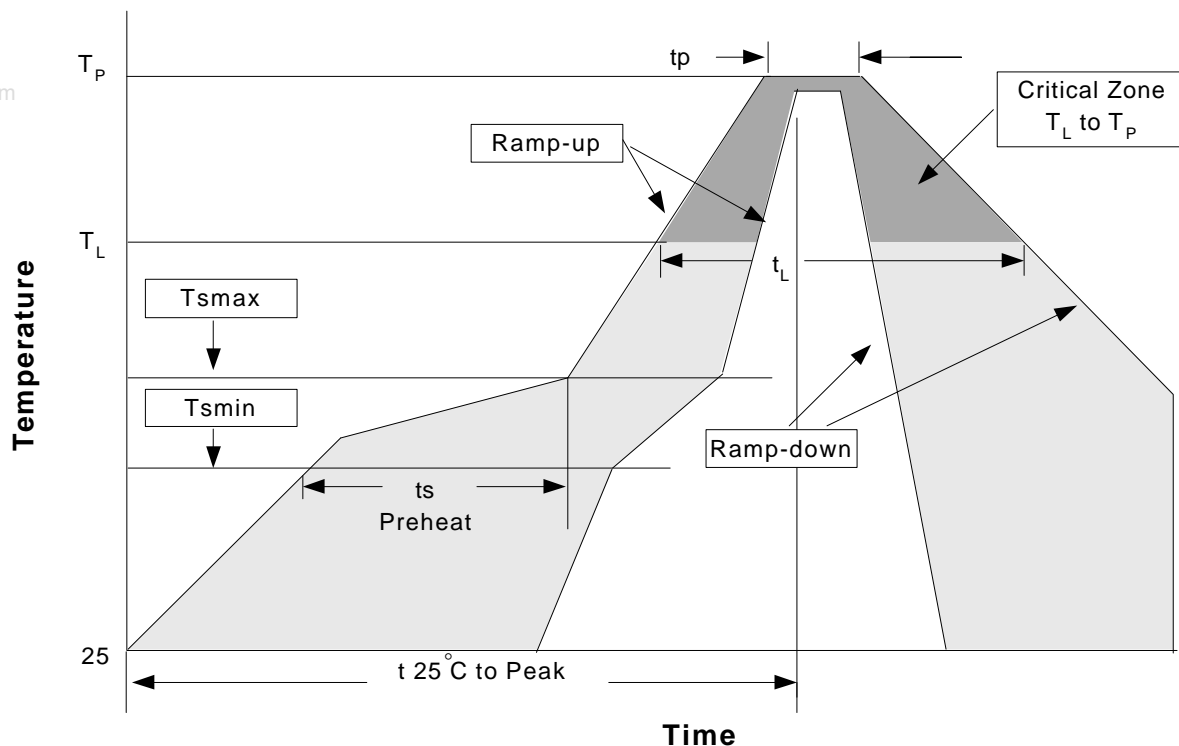


| Dim | Millimeters | | Inches | |
|-----|-------------|------|----------|-------|
| | Min. | Max. | Min. | Max. |
| A | 6.40 | 6.80 | 0.25 | 0.26 |
| B | 5.20 | 5.50 | 0.20 | 0.21 |
| C | 6.80 | 7.20 | 0.26 | 0.27 |
| D | 2.20 | 2.80 | 0.08 | 0.11 |
| P | 1.27 REF | | 0.05 REF | |
| S | 0.50 | 0.80 | 0.02 | 0.03 |
| H | 2.20 | 2.40 | 0.08 | 0.09 |
| J | 0.45 | 0.55 | 0.01 | 0.02 |
| K | 0 | 0.15 | 0 | 0.006 |
| L | 0.90 | 1.50 | 0.03 | 0.06 |
| M | 5.40 | 5.80 | 0.21 | 0.22 |

Physical Specifications

| | |
|--------------------|--|
| Terminal Material | Solder-Plated Copper (Solder Material : 90/10 or 63/37 SnPb), 100%Sn |
| Lead Solderability | Meets EIA Specification RSI86-91, ANSI/J-STD-002 Category 3. |

Reflow Condition (IR/Convection or VPR Reflow)



Classification Reflow Profiles

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--|-------------------------|------------------|
| Average ramp-up rate (T _L to T _P) | 3°C/second max. | 3°C/second max. |
| Preheat | | |
| - Temperature Min (T _{smin}) | 100°C | 150°C |
| - Temperature Max (T _{smax}) | 150°C | 200°C |
| - Time (min to max) (t _s) | 60-120 seconds | 60-180 seconds |
| Time maintained above: | | |
| - Temperature (T _L) | 183°C | 217°C |
| - Time (t _L) | 60-150 seconds | 60-150 seconds |
| Peak/Classification Temperature (T _p) | See table 1 | See table 2 |
| Time within 5°C of actual Peak Temperature (t _p) | 10-30 seconds | 20-40 seconds |
| Ramp-down Rate | 6°C/second max. | 6°C/second max. |
| Time 25°C to Peak Temperature | 6 minutes max. | 8 minutes max. |

Notes: All temperatures refer to topside of the package .Measured on the body surface. (mm)

Classification Reflow Profiles(Cont.)

Table 1. SnPb Eutectic Process – Package Peak Reflow Temperatures

| Package Thickness | Volume mm ³ <350 | Volume mm ³ ≥350 |
|-------------------|--------------------------------|--------------------------------|
| <2.5 mm | 240 +0/-5°C | 225 +0/-5°C |
| ≥2.5 mm | 225 +0/-5°C | 225 +0/-5°C |

Table 2. Pb-free Process – Package Classification Reflow Temperatures

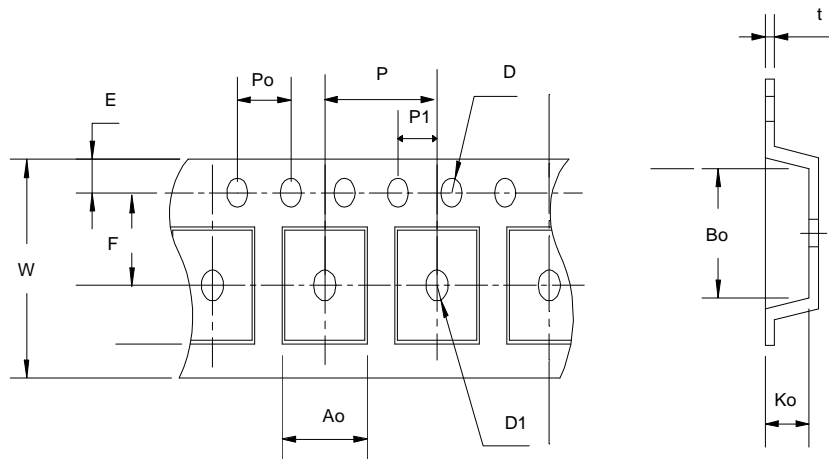
| Package Thickness | Volume mm ³ <350 | Volume mm ³ 350-2000 | Volume mm ³ >2000 |
|-------------------|--------------------------------|------------------------------------|---------------------------------|
| <1.6 mm | 260 +0°C* | 260 +0°C* | 260 +0°C* |
| 1.6 mm – 2.5 mm | 260 +0°C* | 250 +0°C* | 245 +0°C* |
| ≥2.5 mm | 250 +0°C* | 245 +0°C* | 245 +0°C* |

*Tolerance: The device manufacturer/supplier **shall** assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0°C. For example 260°C+0°C) at the rated MSL level.

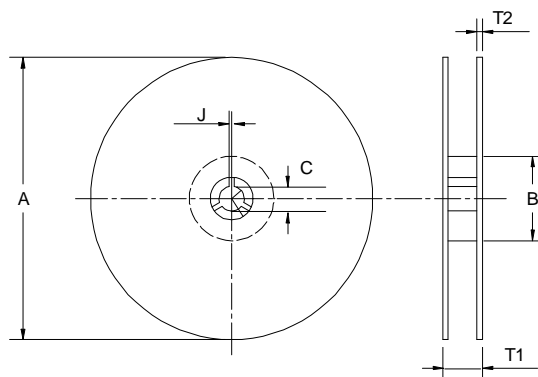
Reliability Test Program

| Test item | Method | Description |
|---------------|---------------------|-------------------------------|
| SOLDERABILITY | MIL-STD-883D-2003 | 245°C, 5 SEC |
| HOLT | MIL-STD-883D-1005.7 | 1000 Hrs Bias @ 125°C |
| PCT | JESD-22-B,A102 | 168 Hrs, 100%RH, 121°C |
| TST | MIL-STD-883D-1011.9 | -65°C~150°C, 200 Cycles |
| ESD | MIL-STD-883D-3015.7 | VHBM > 2KV, VMM > 200V |
| Latch-Up | JESD 78 | 10ms, 1 _{tr} > 100mA |

Carrier Tape & Reel Dimensions



Carrier Tape & Reel Dimensions(Cont.)



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Reel Dimensions

| Application | A | B | C | J | T1 | T2 | W | P | E |
|-------------|------------|-----------|----------------|-----------|--------------------|-----------|----------------------|------------|-------------|
| SOP- 8 | 330 ± 1 | 62 +1.5 | 12.75+ 0.15 | 2 ± 0.5 | 12.4 ± 0.2 | 2 ± 0.2 | 12 ± 0.3 | 8 ± 0.1 | 1.75±0.1 |
| | F | D | D1 | Po | P1 | Ao | Bo | Ko | t |
| | 5.5 ± 1 | 1.55 +0.1 | 1.55+ 0.25 | 4.0 ± 0.1 | 2.0 ± 0.1 | 6.4 ± 0.1 | 5.2± 0.1 | 2.1± 0.1 | 0.3±0.013 |
| Application | A | B | C | J | T1 | T2 | W | P | E |
| SOT-89 | 178 ± 1 | 70 ± 2 | 13.5 ± 0.15 | 3 ± 0.15 | 14 ± 2 | 1.3 ± 0.3 | 12 + 0.3 12 - 0.1 | 8 ± 0.1 | 1.75± 0.1 |
| | F | D | D1 | Po | P1 | Ao | Bo | Ko | t |
| | 5.5 ± 0.05 | 1.5 ± 0.1 | 1.5 ± 0.1 | 4.0 ± 0.1 | 2.0 ± 0.1 | 4.8 ± 0.1 | 4.5 ± 0.1 | 1.80 ± 0.1 | 0.3 ± 0.013 |
| Application | A | B | C | J | T1 | T2 | W | P | E |
| SOT-223 | 330±1 | 62±1.5 | 12.75± 0.15 | 2 ± 0.6 | 12.4 +0.2 | 2± 0.2 | 12 ± 0.3 | 8 ± 0.1 | 1.75± 0.1 |
| | F | D | D1 | Po | P1 | Ao | Bo | Ko | t |
| | 5.5 ± 0.05 | 1.5+ 0.1 | 1.5+ 0.1 | 4.0 ± 0.1 | 2.0 ± 0.05 | 6.9 ± 0.1 | 7.5 ± 0.1 | 2.1 ± 0.1 | 0.3±0.05 |
| Application | A | B | C | J | T1 | T2 | W | P | E |
| TO-252 | 330 ± 3 | 100 ± 2 | 13 ± 0.5 | 2 ± 0.5 | 16.4 + 0.3 -0.2 | 2.5 ± 0.5 | 16 + 0.3 - 0.1 | 8 ± 0.1 | 1.75 ± 0.1 |
| | F | D | D1 | Po | P1 | Ao | Bo | Ko | t |
| | 7.5 ± 0.1 | 1.5 ± 0.1 | 1.5 ± 0.25 | 4.0 ± 0.1 | 2.0 ± 0.1 | 6.8 ± 0.1 | 10.4 ± 0.1 | 2.5 ± 0.1 | 0.3 ± 0.05 |

(mm)

Cover Tape Dimensions

| Application | Carrier Width | Cover Tape Width | Devices Per Reel |
|-------------|---------------|------------------|------------------|
| SOP- 8 | 12 | 9.3 | 2500 |
| SOT- 89 | 12 | 9.3 | 1000 |
| SOT- 223 | 12 | 9.3 | 2500 |
| TO- 252 | 16 | 13.3 | 2500 |

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